

Features

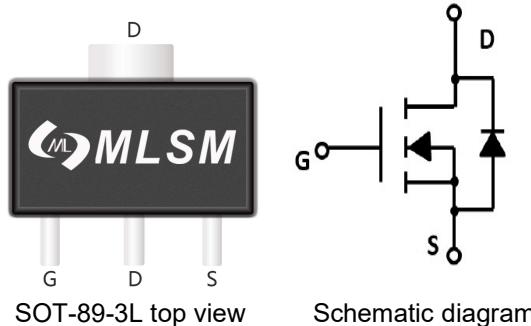
- Trench Power LV MOSFET technology
- High Power and current handling capability

Product Summary

V _{DS}	R _{DS(ON)} MAX	I _D MAX
20V	27mΩ@4.5V	6A
	35mΩ@2.5V	

Application

- PWM application
- Load switch



0C06A: Device code
XXXX : Code

Marking and pin assignment



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)			
V _{DS}	Drain-Source Breakdown Voltage	20	V
V _{GS}	Gate-Source Voltage	±12	V
T _J	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-50 to 150	°C
I _S	Diode Continuous Forward Current	T _c =25°C 6	A
Mounted on Large Heat Sink			
I _{DM}	Pulse Drain Current Tested	T _c =25°C 28	A
I _D	Continuous Drain Current	T _c =25°C 6	A
P _D	Maximum Power Dissipation	T _c =25°C 0.8	W
R _{θJA}	Thermal Resistance Junction-Ambient	125	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MZ0C06A	SOT-89-3L	0C06A	1,000	10,000	40,000	7" reel

Electrical Characteristics (TJ=25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	20	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =20V, V _{GS} =0V	--	--	1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±12V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	0.45	0.7	1.0	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =4.5V, I _D =6.0A	--	20	27	mΩ
		V _{GS} =2.5V, I _D =3.0A	--	25	35	mΩ
		V _{GS} =1.8V, I _D =1.0A	--	38	50	mΩ
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =10V, V _{GS} =0V, f=1MHz	--	378	--	pF
C _{OSS}	Output Capacitance		--	74	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	58	--	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DS} =10V, I _D =4.5A, V _{GS} =4.5V	--	6.05	--	nC
Q _{gs}	Gate Source Charge		--	1.07	--	nC
Q _{gd}	Gate Drain Charge		--	1.95	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =10V, R _L =1Ω, V _{GS} =4.5V, R _G =3Ω	--	4.2	--	nS
t _r	Turn-on Rise Time		--	19.8	--	nS
t _{d(off)}	Turn-Off Delay Time		--	22.6	--	nS
t _f	Turn-Off Fall Time		--	23.2	--	nS
Source-Drain Diode Characteristics						
V _{SD}	Forward on voltage	T _J =25°C, I _S =6A	--	--	1.2	V

Typical Operating Characteristics

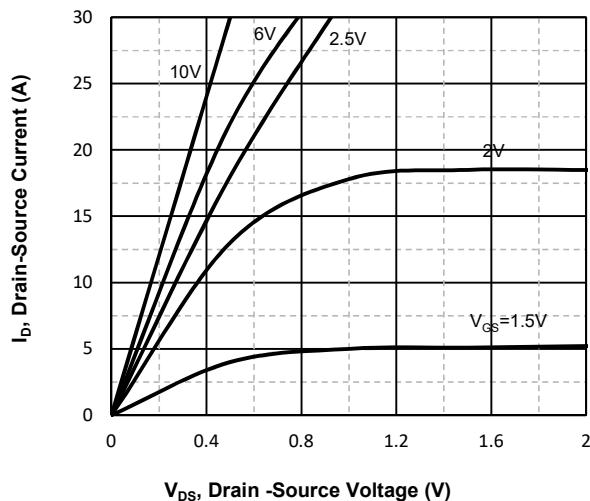


Fig1. Typical Output Characteristics

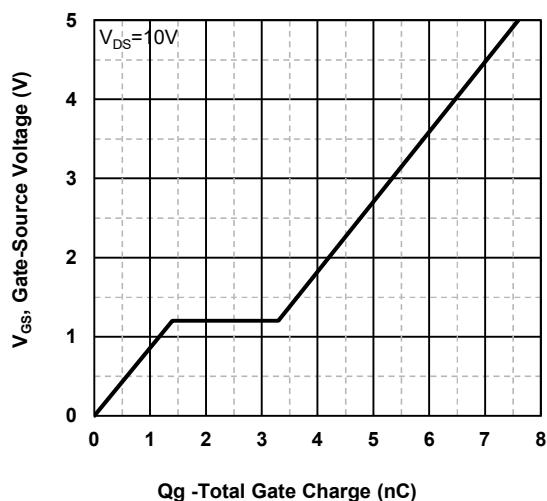


Fig2. Typical Gate Charge Vs.Gate-Source Voltage

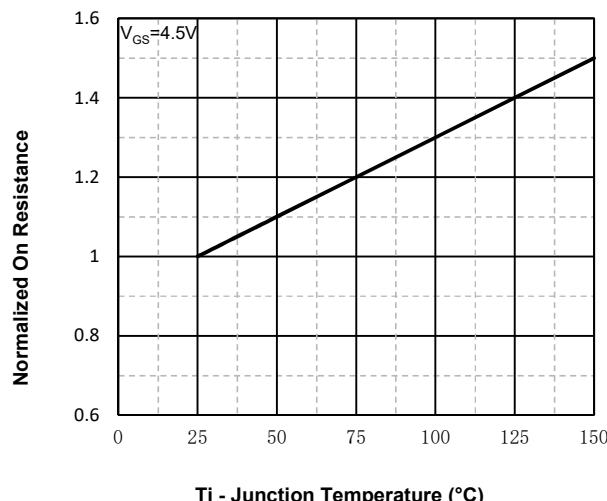


Fig3. Normalized On-Resistance Vs. Temperature

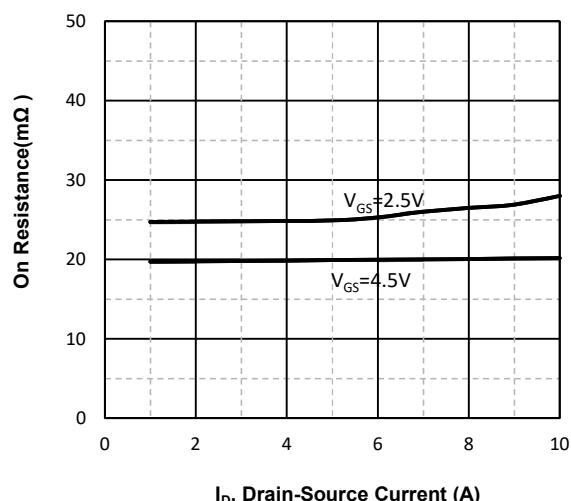


Fig4. On-Resistance Vs. Drain-Source Current

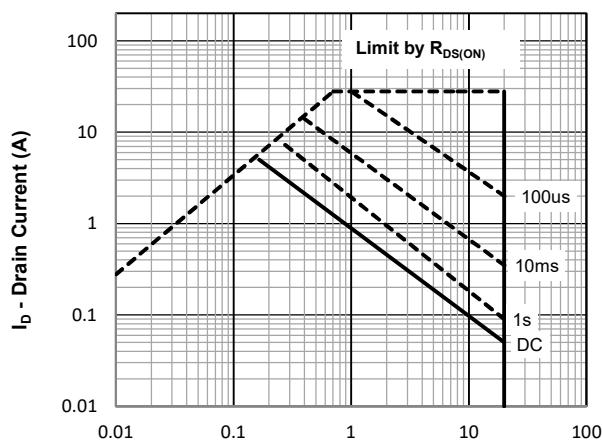


Fig5. Maximum Safe Operating Area

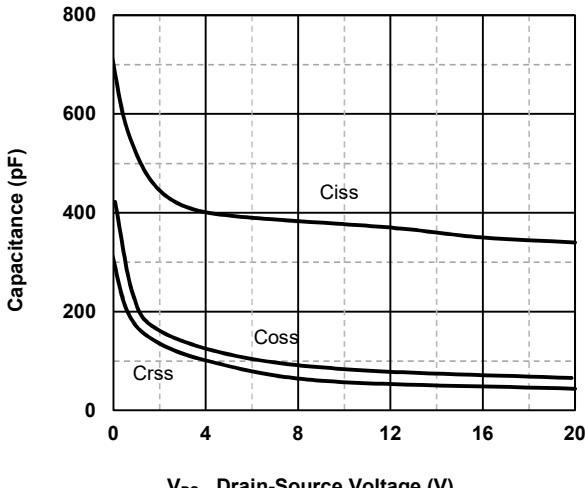
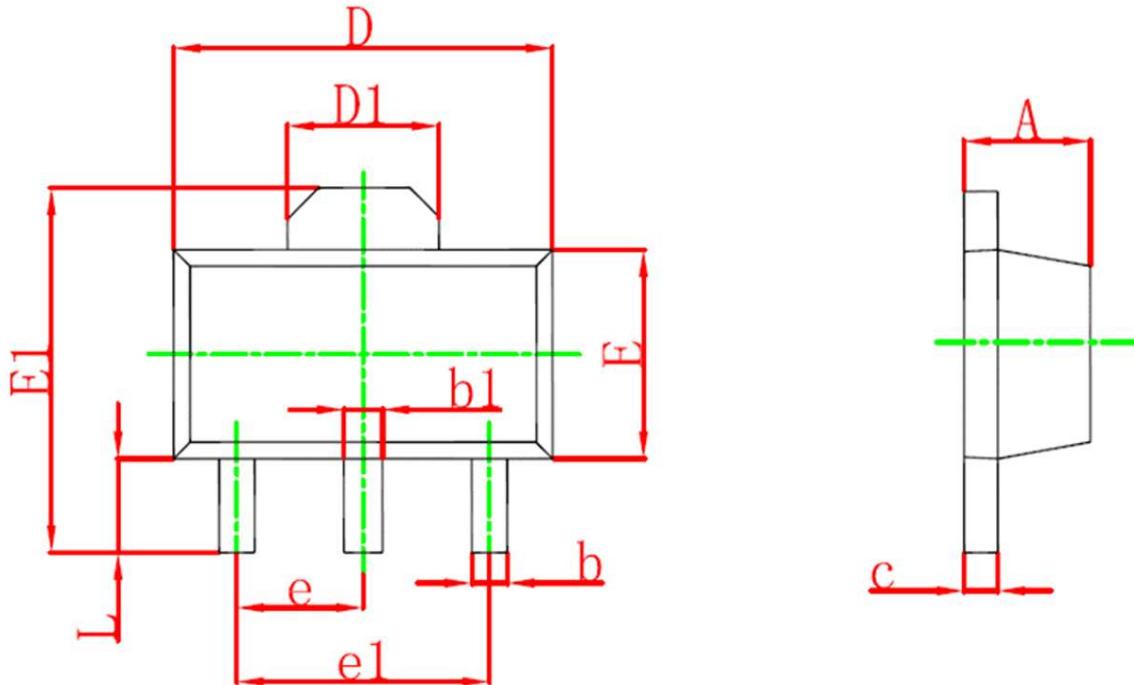


Fig6 Typical Capacitance Vs.Drain-Source Voltage

SOT-89-3L Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions in Inches	
	Min	Max	Min	Max
A	1.400	1.600	0.055	0.063
b	0.320	0.520	0.013	0.020
b1	0.400	0.580	0.016	0.023
c	0.350	0.440	0.014	0.017
D	4.400	4.600	0.173	0.181
D1	1.550 REF		0.061 REF	
E	2.300	2.600	0.091	0.102
E1	3.940	4.250	0.155	0.167
e	1.500 TYP		0.060 TYP	
e1	3.000 TYP		0.118 TYP	
L	0.900	1.200	0.035	0.047